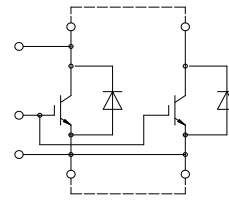


IHM-B 模块 采用第四代沟槽栅/场终止IGBT4和第四代发射极控制二极管 和预涂导热介质  
 IHM-B module with Trench/Fieldstop IGBT4 and Emitter Controlled 4 diode and pre-applied Thermal Interface Material



external connection  
(to be done)

$V_{CES} = 1700V$   
 $I_{C\ nom} = 1200A / I_{CRM} = 2400A$

### 典型应用

- 大功率变流器
- 电机传动

### 电气特性

- 提高工作结温  $T_{vj\ op}$
- 低开关损耗
- 低  $V_{CEsat}$
- $T_{vj\ op} = 150^{\circ}C$

### 机械特性

- 4 kV 交流 1分钟 绝缘
- 封装的 CTI > 400
- 高爬电距离和电气间隙
- 高功率密度
- IHM B 封装
- 铜基板
- 符合RoHS
- 预涂导热介质

### Typical Applications

- High power converters
- Motor drives

### Electrical Features

- Extended operating temperature  $T_{vj\ op}$
- Low switching losses
- Low  $V_{CEsat}$
- $T_{vj\ op} = 150^{\circ}C$

### Mechanical Features

- 4 kV AC 1min insulation
- Package with CTI > 400
- High creepage and clearance distances
- High power density
- IHM B housing
- Copper base plate
- RoHS compliant
- Pre-applied Thermal Interface Material

## Module Label Code

Barcode Code 128



DMX - Code



Content of the Code

Content of the Code	Digit
Module Serial Number	1 - 5
Module Material Number	6 - 11
Production Order Number	12 - 19
Datecode (Production Year)	20 - 21
Datecode (Production Week)	22 - 23

## IGBT, 逆变器 / IGBT, Inverter

### 最大额定值 / Maximum Rated Values

集电极 - 发射极电压 Collector-emitter voltage	$T_{vj} = 25^{\circ}\text{C}$	$V_{CES}$	1700	V
连续集电极直流电流 Continuous DC collector current	$T_H = 90^{\circ}\text{C}, T_{vj\text{max}} = 175^{\circ}\text{C}$	$I_{C\text{nom}}$	1200	A
集电极重复峰值电流 Repetitive peak collector current	$t_P = 1\text{ ms}$	$I_{CRM}$	2400	A
栅极 - 发射极峰值电压 Gate-emitter peak voltage		$V_{GES}$	+/-20	V

### 特征值 / Characteristic Values

		min.	typ.	max.		
集电极 - 发射极饱和电压 Collector-emitter saturation voltage	$I_C = 1200\text{ A}, V_{GE} = 15\text{ V}$		1,95	2,30	V	
	$I_C = 1200\text{ A}, V_{GE} = 15\text{ V}$		2,35	2,75	V	
	$I_C = 1200\text{ A}, V_{GE} = 15\text{ V}$		2,45	2,90	V	
栅极阈值电压 Gate threshold voltage	$I_C = 48,0\text{ mA}, V_{CE} = V_{GE}, T_{vj} = 25^{\circ}\text{C}$	$V_{GEth}$	5,20	5,80	6,40	V
栅极电荷 Gate charge	$V_{GE} = -15\text{ V} \dots +15\text{ V}$	$Q_G$		12,5	$\mu\text{C}$	
内部栅极电阻 Internal gate resistor	$T_{vj} = 25^{\circ}\text{C}$	$R_{Gint}$		1,6	$\Omega$	
输入电容 Input capacitance	$f = 1\text{ MHz}, T_{vj} = 25^{\circ}\text{C}, V_{CE} = 25\text{ V}, V_{GE} = 0\text{ V}$	$C_{ies}$		97,0	nF	
反向传输电容 Reverse transfer capacitance	$f = 1\text{ MHz}, T_{vj} = 25^{\circ}\text{C}, V_{CE} = 25\text{ V}, V_{GE} = 0\text{ V}$	$C_{res}$		3,15	nF	
集电极-发射极截止电流 Collector-emitter cut-off current	$V_{CE} = 1700\text{ V}, V_{GE} = 0\text{ V}, T_{vj} = 25^{\circ}\text{C}$	$I_{CES}$			5,0	mA
栅极-发射极漏电流 Gate-emitter leakage current	$V_{CE} = 0\text{ V}, V_{GE} = 20\text{ V}, T_{vj} = 25^{\circ}\text{C}$	$I_{GES}$			400	nA
开通延迟时间(电感负载) Turn-on delay time, inductive load	$I_C = 1200\text{ A}, V_{CE} = 900\text{ V}$		0,68		$\mu\text{s}$	
	$V_{GE} = \pm 15\text{ V}$		0,79		$\mu\text{s}$	
	$R_{Gon} = 0,68\ \Omega$		0,81		$\mu\text{s}$	
上升时间(电感负载) Rise time, inductive load	$I_C = 1200\text{ A}, V_{CE} = 900\text{ V}$		0,14		$\mu\text{s}$	
	$V_{GE} = \pm 15\text{ V}$		0,145		$\mu\text{s}$	
	$R_{Gon} = 0,68\ \Omega$		0,145		$\mu\text{s}$	
关断延迟时间(电感负载) Turn-off delay time, inductive load	$I_C = 1200\text{ A}, V_{CE} = 900\text{ V}$		1,10		$\mu\text{s}$	
	$V_{GE} = \pm 15\text{ V}$		1,20		$\mu\text{s}$	
	$R_{Goff} = 1,0\ \Omega$		1,25		$\mu\text{s}$	
下降时间(电感负载) Fall time, inductive load	$I_C = 1200\text{ A}, V_{CE} = 900\text{ V}$		0,18		$\mu\text{s}$	
	$V_{GE} = \pm 15\text{ V}$		0,43		$\mu\text{s}$	
	$R_{Goff} = 1,0\ \Omega$		0,51		$\mu\text{s}$	
开通损耗能量(每脉冲) Turn-on energy loss per pulse	$I_C = 1200\text{ A}, V_{CE} = 900\text{ V}, L_S = 50\text{ nH}$		280		mJ	
	$V_{GE} = \pm 15\text{ V}, di/dt = 9000\text{ A}/\mu\text{s} (T_{vj} = 150^{\circ}\text{C})$		370		mJ	
	$R_{Gon} = 0,68\ \Omega$		400		mJ	
关断损耗能量(每脉冲) Turn-off energy loss per pulse	$I_C = 1200\text{ A}, V_{CE} = 900\text{ V}, L_S = 50\text{ nH}$		240		mJ	
	$V_{GE} = \pm 15\text{ V}, du/dt = 2950\text{ V}/\mu\text{s} (T_{vj} = 150^{\circ}\text{C})$		380		mJ	
	$R_{Goff} = 1,0\ \Omega$		420		mJ	
短路数据 SC data	$V_{GE} \leq 15\text{ V}, V_{CC} = 1000\text{ V}$ $V_{CEmax} = V_{CES} - L_{SCE} \cdot di/dt$ $t_P \leq 10\ \mu\text{s}, T_{vj} = 150^{\circ}\text{C}$	$I_{SC}$		5500	A	
结 - 散热器热阻 Thermal resistance, junction to heatsink	每个 IGBT / per IGBT valid with IFX pre-applied thermal interface material	$R_{thJH}$		23,4	K/kW	
在开关状态下温度 Temperature under switching conditions		$T_{vj\text{op}}$	-40	150	$^{\circ}\text{C}$	

## 二极管, 逆变器 / Diode, Inverter 最大额定值 / Maximum Rated Values

反向重复峰值电压 Repetitive peak reverse voltage	$T_{vj} = 25^{\circ}\text{C}$	$V_{RRM}$	1700	V
连续正向直流电流 Continuous DC forward current		$I_F$	1200	A
正向重复峰值电流 Repetitive peak forward current	$t_P = 1\text{ ms}$	$I_{FRM}$	2400	A
$I^2t$ -值 $I^2t$ - value	$V_R = 0\text{ V}, t_P = 10\text{ ms}, T_{vj} = 125^{\circ}\text{C}$ $V_R = 0\text{ V}, t_P = 10\text{ ms}, T_{vj} = 150^{\circ}\text{C}$	$I^2t$	235 225	$\text{kA}^2\text{s}$ $\text{kA}^2\text{s}$

## 特征值 / Characteristic Values

				min.	typ.	max.	
正向电压 Forward voltage	$I_F = 1200\text{ A}, V_{GE} = 0\text{ V}$	$T_{vj} = 25^{\circ}\text{C}$	$V_F$		1,80	2,20	V
	$I_F = 1200\text{ A}, V_{GE} = 0\text{ V}$	$T_{vj} = 125^{\circ}\text{C}$			1,90	2,30	V
	$I_F = 1200\text{ A}, V_{GE} = 0\text{ V}$	$T_{vj} = 150^{\circ}\text{C}$			1,95	2,40	V
反向恢复峰值电流 Peak reverse recovery current	$I_F = 1200\text{ A}, -di_F/dt = 9000\text{ A}/\mu\text{s} (T_{vj}=150^{\circ}\text{C})$ $V_R = 900\text{ V}$ $V_{GE} = -15\text{ V}$	$T_{vj} = 25^{\circ}\text{C}$	$I_{RM}$		1350		A
		$T_{vj} = 125^{\circ}\text{C}$			1600		A
		$T_{vj} = 150^{\circ}\text{C}$			1650		A
恢复电荷 Recovered charge	$I_F = 1200\text{ A}, -di_F/dt = 9000\text{ A}/\mu\text{s} (T_{vj}=150^{\circ}\text{C})$ $V_R = 900\text{ V}$ $V_{GE} = -15\text{ V}$	$T_{vj} = 25^{\circ}\text{C}$	$Q_r$		300		$\mu\text{C}$
		$T_{vj} = 125^{\circ}\text{C}$			515		$\mu\text{C}$
		$T_{vj} = 150^{\circ}\text{C}$			580		$\mu\text{C}$
反向恢复损耗 (每脉冲) Reverse recovery energy	$I_F = 1200\text{ A}, -di_F/dt = 9000\text{ A}/\mu\text{s} (T_{vj}=150^{\circ}\text{C})$ $V_R = 900\text{ V}$ $V_{GE} = -15\text{ V}$	$T_{vj} = 25^{\circ}\text{C}$	$E_{rec}$		170		mJ
		$T_{vj} = 125^{\circ}\text{C}$			325		mJ
		$T_{vj} = 150^{\circ}\text{C}$			370		mJ
结 - 散热器热阻 Thermal resistance, junction to heatsink	每个二极管 / per diode valid with IFX pre-applied thermal interface material	$R_{thJH}$				39,0	K/kW
在开关状态下温度 Temperature under switching conditions		$T_{vj\text{ op}}$	-40			150	$^{\circ}\text{C}$

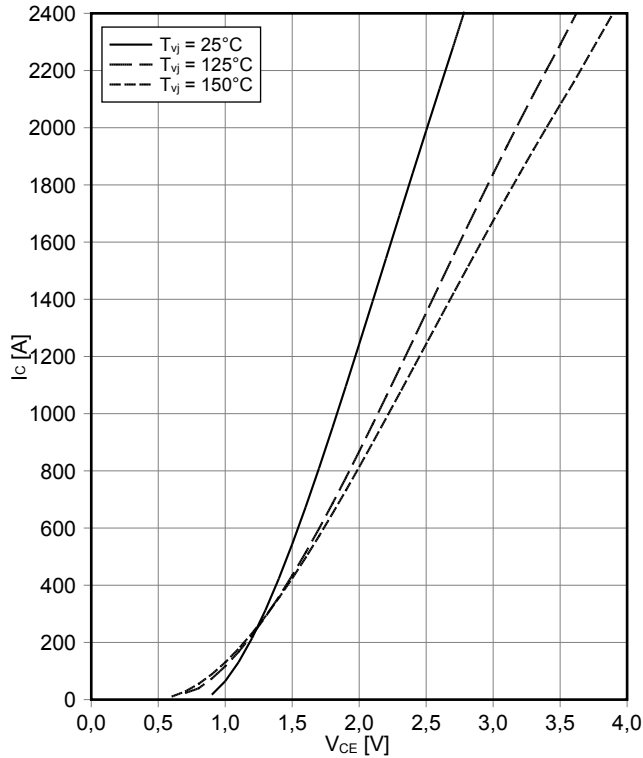
## 模块 / Module

绝缘测试电压 Isolation test voltage	RMS, f = 50 Hz, t = 1 min.	V <sub>ISOL</sub>	4,0		kV
模块基板材料 Material of module baseplate			Cu		
内部绝缘 Internal isolation	基本绝缘 (class 1, IEC 61140) basic insulation (class 1, IEC 61140)		Al <sub>2</sub> O <sub>3</sub>		
爬电距离 Creepage distance	端子至散热器 / terminal to heatsink 端子至端子 / terminal to terminal		32,2 32,2		mm
电气间隙 Clearance	端子至散热器 / terminal to heatsink 端子至端子 / terminal to terminal		19,1 19,1		mm
相对电痕指数 Comperative tracking index		CTI	> 400		
			min.	typ.	max.
杂散电感, 模块 Stray inductance module		L <sub>sCE</sub>		9,0	nH
模块引线电阻, 端子-芯片 Module lead resistance, terminals - chip	T <sub>H</sub> = 25°C, 每个开关 / per switch	R <sub>CC+EE'</sub>		0,18	mΩ
储存温度 Storage temperature		T <sub>stg</sub>	-40		125 °C
最高基板工作温度 Maximum baseplate operation temperature		T <sub>BPmax</sub>			125 °C
模块安装的安装扭矩 Mounting torque for modul mounting	螺丝 M6 根据相应的应用手册进行安装 Screw M6 - Mounting according to valid application note	M	4,25		5,75 Nm
端子联接扭矩 Terminal connection torque	螺丝 M4 根据相应的应用手册进行安装 Screw M4 - Mounting according to valid application note 螺丝 M8 根据相应的应用手册进行安装 Screw M8 - Mounting according to valid application note	M	1,8 8,0	- -	2,1 10 Nm
重量 Weight		G		1300	g

Lagerung und Transport von Modulen mit TIM laut AN2012-07  
Storage and shipment of modules with TIM according to AN2012-07

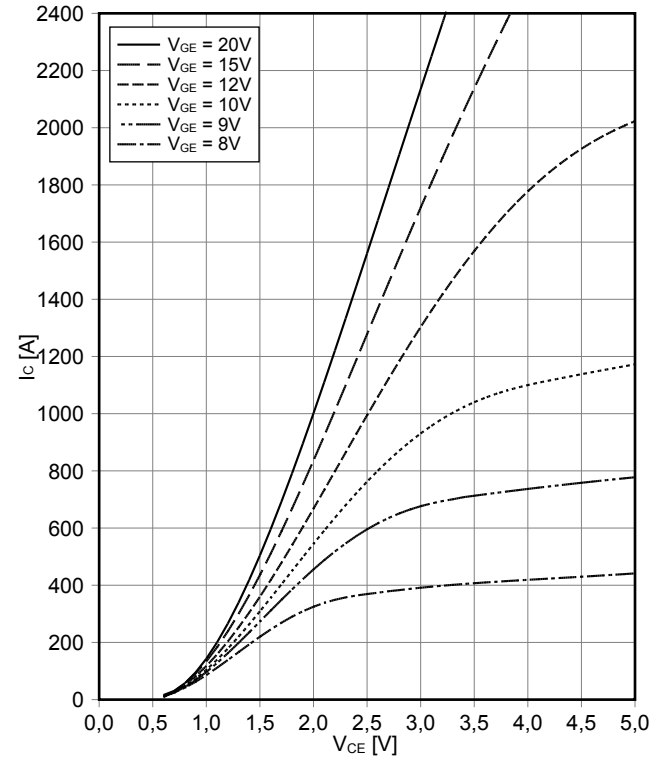
输出特性 IGBT, 逆变器 (典型)  
output characteristic IGBT, Inverter (typical)

$I_C = f(V_{CE})$   
 $V_{GE} = 15\text{ V}$



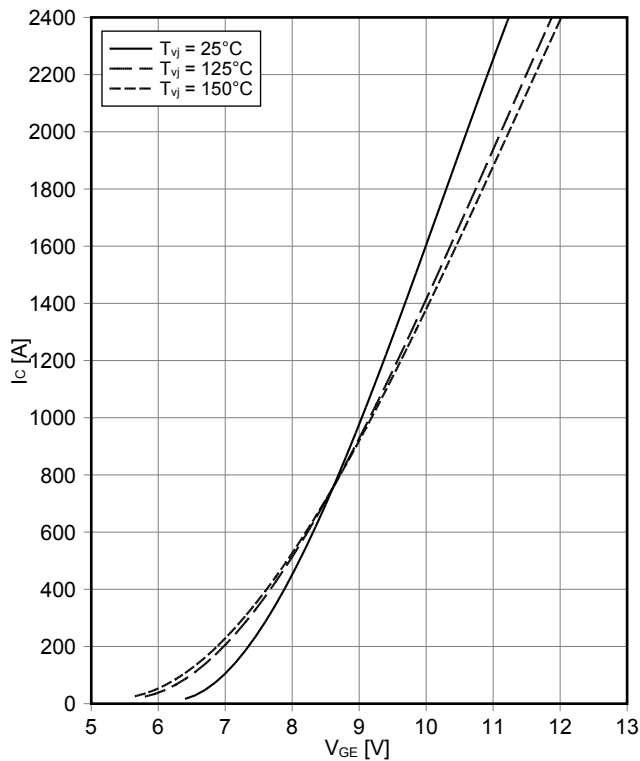
输出特性 IGBT, 逆变器 (典型)  
output characteristic IGBT, Inverter (typical)

$I_C = f(V_{CE})$   
 $T_{vj} = 150^\circ\text{C}$



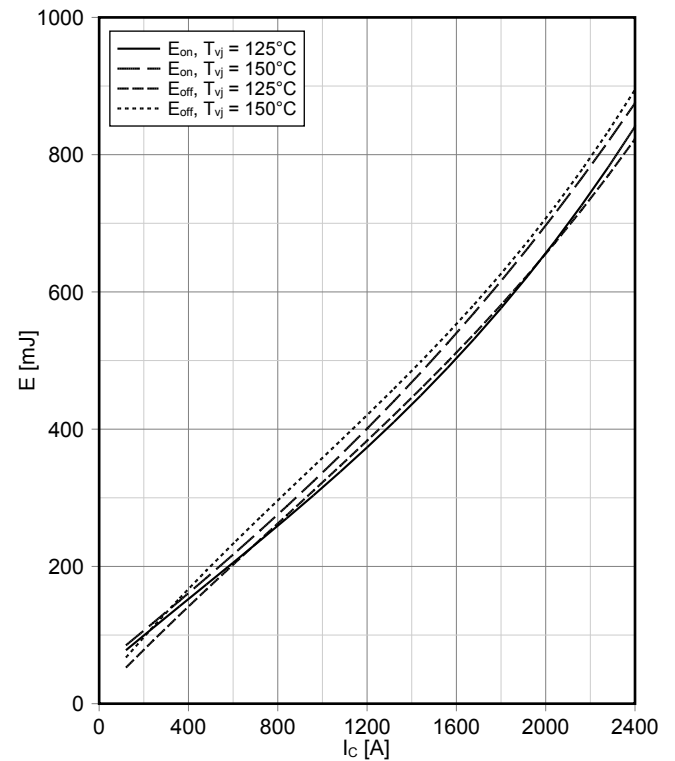
传输特性 IGBT, 逆变器 (典型)  
transfer characteristic IGBT, Inverter (typical)

$I_C = f(V_{GE})$   
 $V_{CE} = 20\text{ V}$



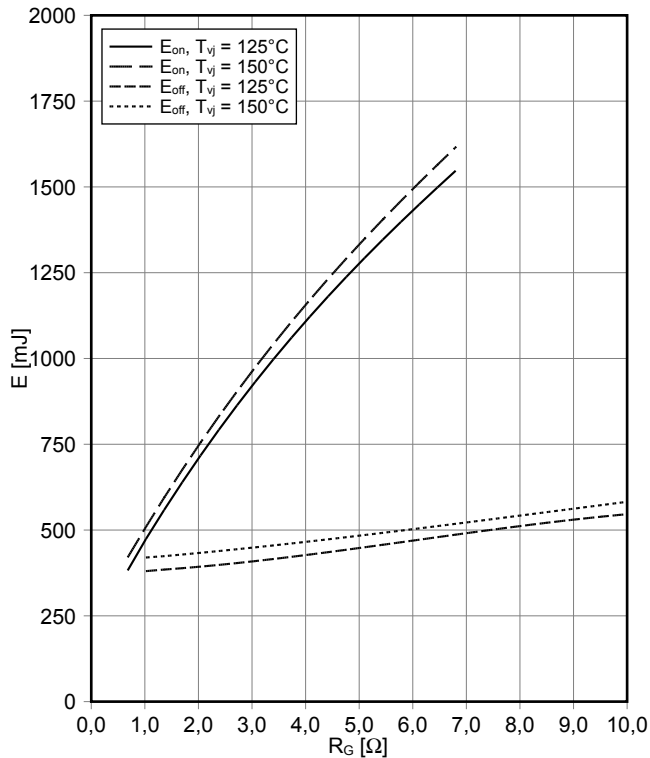
开关损耗 IGBT, 逆变器 (典型)  
switching losses IGBT, Inverter (typical)

$E_{on} = f(I_C)$ ,  $E_{off} = f(I_C)$   
 $V_{GE} = \pm 15\text{ V}$ ,  $R_{Gon} = 0.68\ \Omega$ ,  $R_{Goff} = 1\ \Omega$ ,  $V_{CE} = 900\text{ V}$

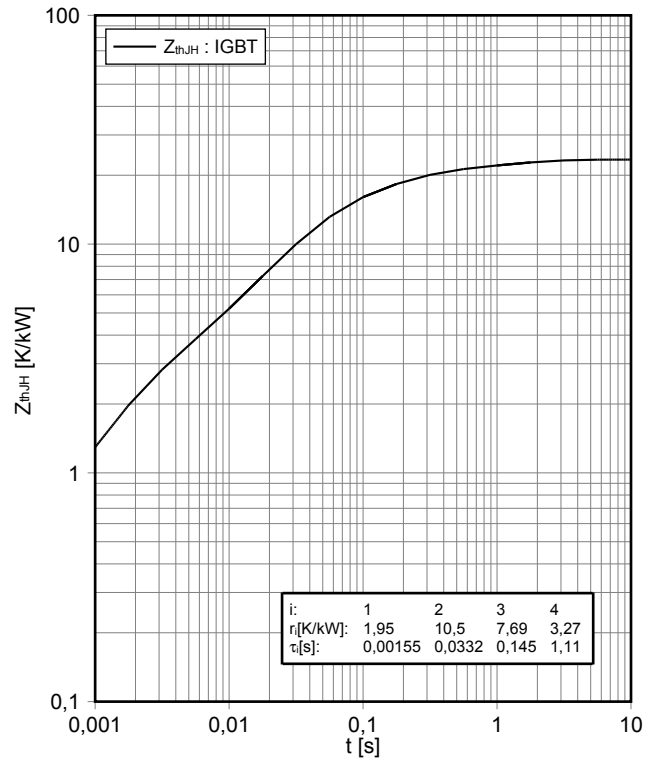


**开关损耗 IGBT, 逆变器 (典型)**  
**switching losses IGBT, Inverter (typical)**

$E_{on} = f(R_G), E_{off} = f(R_G)$   
 $V_{GE} = \pm 15 \text{ V}, I_C = 1200 \text{ A}, V_{CE} = 900 \text{ V}$

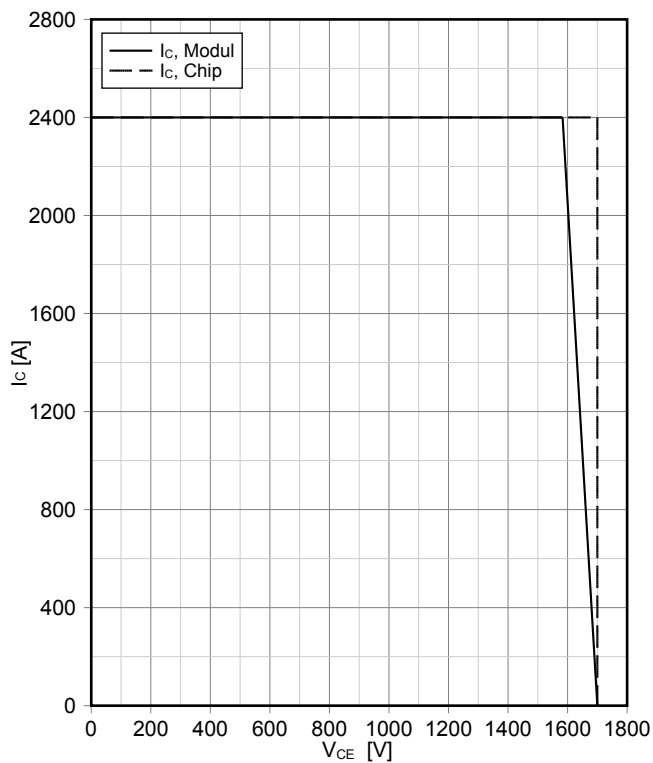


**瞬态热阻抗 IGBT, 逆变器**  
**transient thermal impedance IGBT, Inverter**  
 $Z_{thJH} = f(t)$

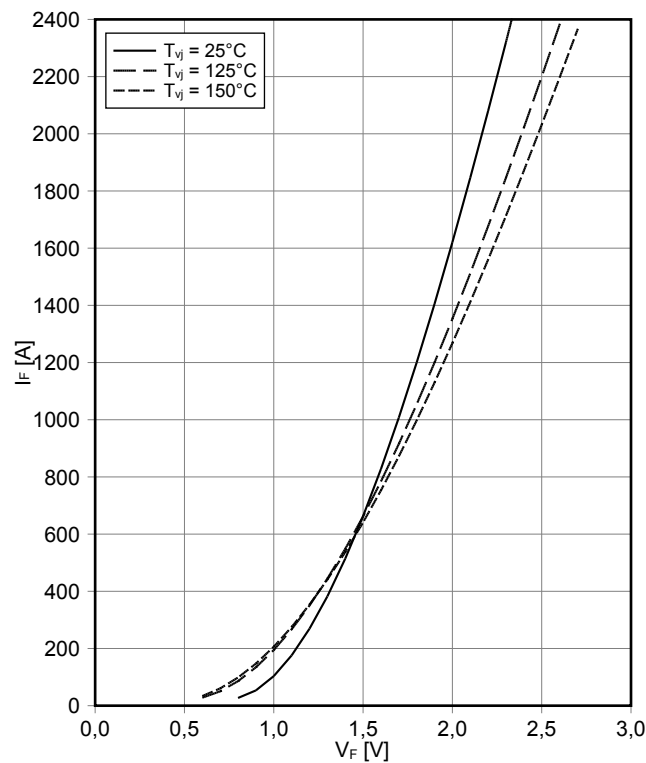


**反偏安全工作区 IGBT, 逆变器 (RBSOA)**  
**reverse bias safe operating area IGBT, Inverter (RBSOA)**

$I_C = f(V_{CE})$   
 $V_{GE} = \pm 15 \text{ V}, R_{Goff} = 1 \Omega, T_{vj} = 150^\circ\text{C}$

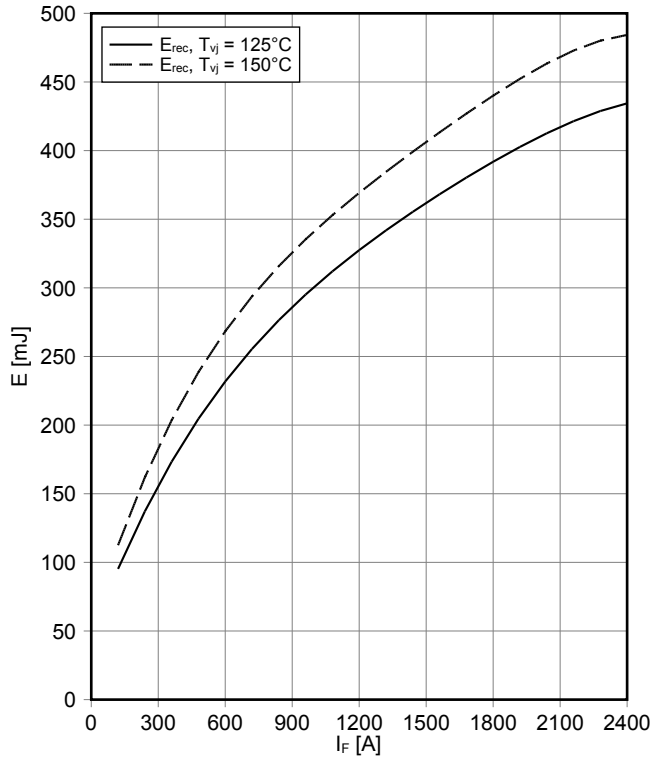


**正向偏压特性 二极管, 逆变器 (典型)**  
**forward characteristic of Diode, Inverter (typical)**  
 $I_F = f(V_F)$



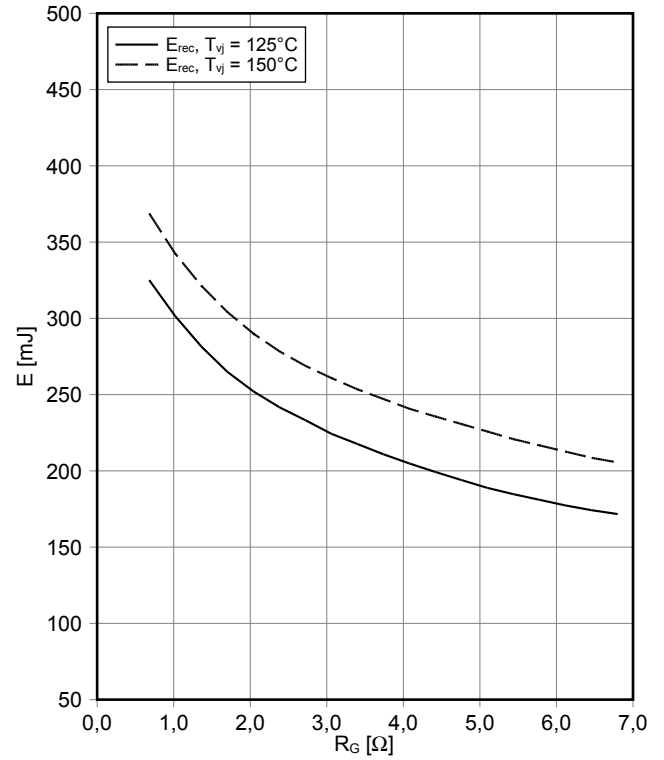
开关损耗 二极管,逆变器 (典型)  
switching losses Diode, Inverter (typical)

$E_{rec} = f(I_F)$   
 $R_{Gon} = 0.68 \Omega, V_{CE} = 900 V$



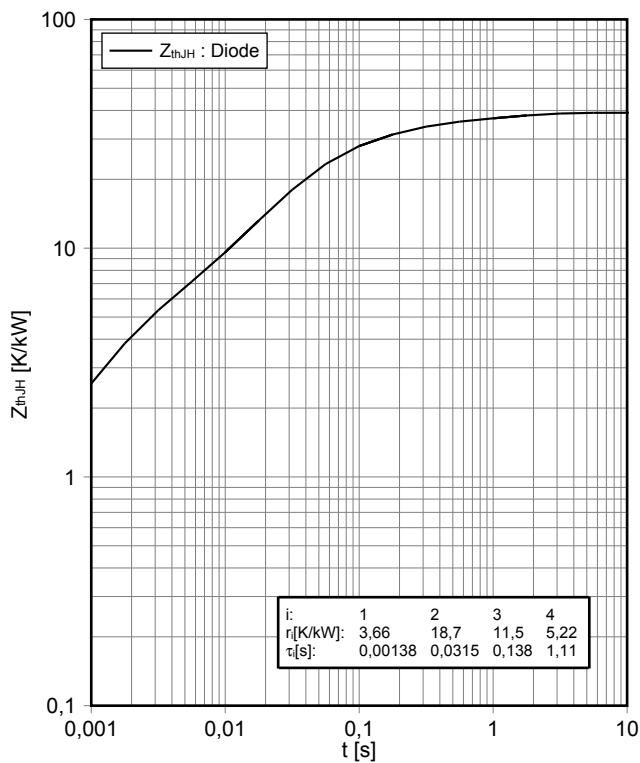
开关损耗 二极管,逆变器 (典型)  
switching losses Diode, Inverter (typical)

$E_{rec} = f(R_G)$   
 $I_F = 1200 A, V_{CE} = 900 V$

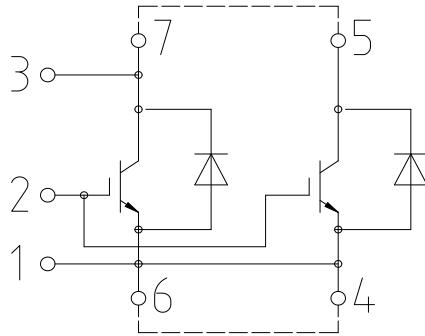


瞬态热阻抗 二极管,逆变器  
transient thermal impedance Diode, Inverter

$Z_{thJH} = f(t)$

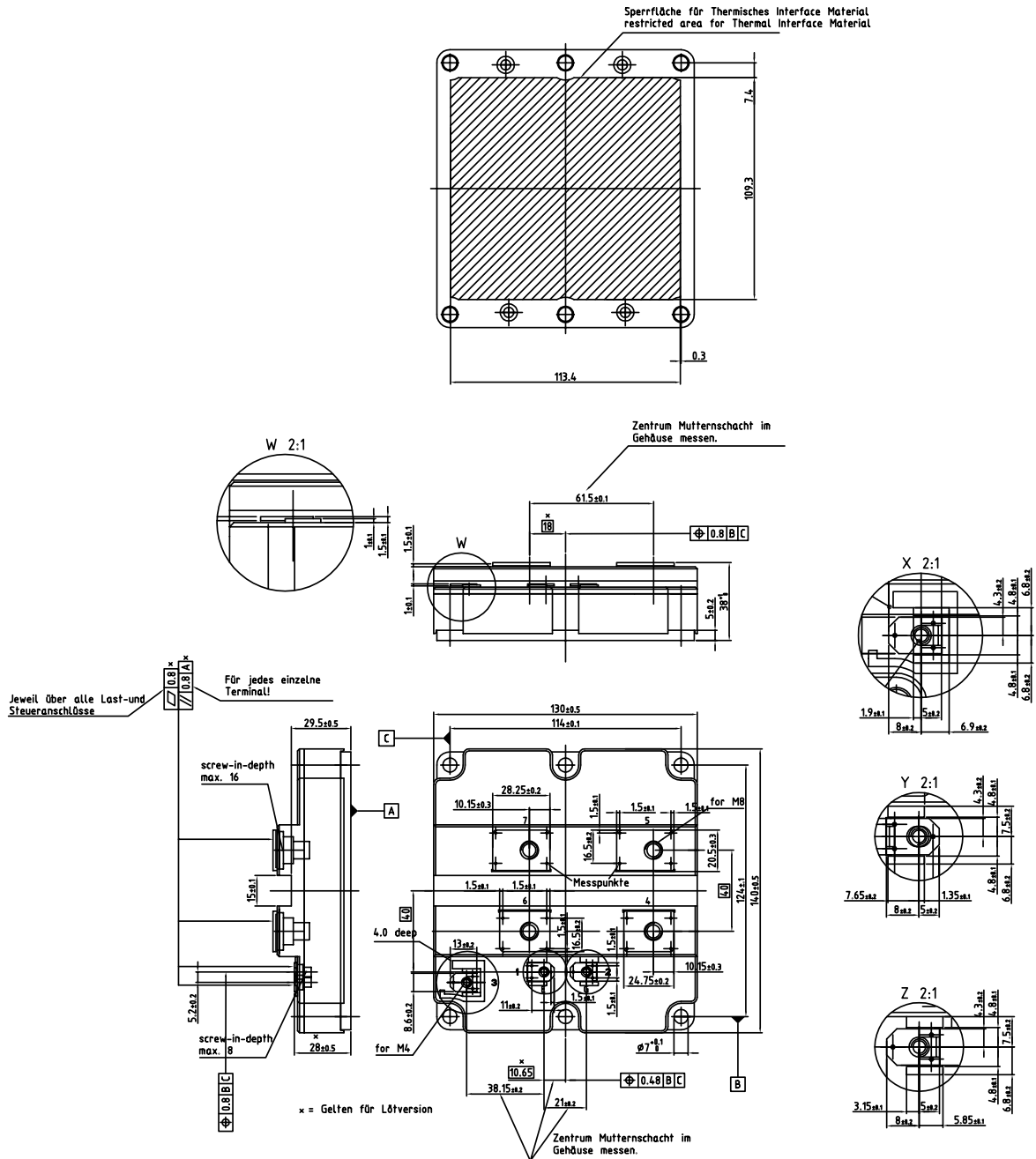


## 接线图 / Circuit diagram



external connection  
(to be done)

## 封装尺寸 / Package outlines





#### Trademarks of Infineon Technologies AG

µHVIC™, µIPM™, µPFC™, AU-ConvertIR™, AURIX™, C166™, CanPAK™, CIPOS™, CIPURSE™, CoolDP™, CoolGaN™, COOLiR™, CoolMOS™, CoolSET™, CoolSiC™, DAVE™, DI-POL™, DirectFET™, DrBlade™, EasyPIM™, EconoBRIDGE™, EconoDUAL™, EconoPACK™, EconoPIM™, EiceDRIVER™, eupec™, FCOS™, GaNpowIR™, HEXFET™, HITFET™, HybridPACK™, iMOTION™, IRAM™, ISOFACE™, IsoPACK™, LEDrivIR™, LITIX™, MIPAQ™, ModSTACK™, my-d™, NovalithIC™, OPTIGA™, OptiMOS™, ORIGA™, PowIRaudio™, PowIRstage™, PrimePACK™, PrimeSTACK™, PROFET™, PRO-SiL™, RASIC™, REAL3™, SmartLEWIS™, SOLID FLASH™, SPOC™, StrongIRFET™, SuplRBuck™, TEMPFET™, TRENCHSTOP™, TriCore™, UHVIC™, XHP™, XMC™

Trademarks updated November 2015

#### Other Trademarks

All referenced product or service names and trademarks are the property of their respective owners.

Edition 2016-10-17

Published by  
Infineon Technologies AG  
81726 München, Germany

© 2016 Infineon Technologies AG.  
All Rights Reserved.

Do you have a question about this document?  
Email: [erratum@infineon.com](mailto:erratum@infineon.com)

#### 重要提示

本档所提供的任何信息绝不当被视为针对任何条件或者品质而做出的保证（质量保证）。英飞凌对于本档中所提及的任何事例、提示或者任何特定数值及/或任何关于产品应用方面的信息均在此明确声明其不承担任何保证或者责任，包括但不限于其不侵犯任何第三方知识产权的保证均在此排除。

此外，本档所提供的任何信息均取决于客户履行本档所载明的义务和客户遵守适用于客户产品以及与客户对于英飞凌产品的应用所相关的任何法律要求、规范和标准。

本档所含的数据仅供经过专业技术培训的人员使用。客户自身的技术部门有义务对于产品是否适宜于其预期的应用和针对该等应用而言本档中所提供的信息是否充分自行予以评估。

如需产品、技术、交付条款和条件以及价格等进一步信息，请向离您最近的英飞凌科技办公室接洽（[www.infineon.com](http://www.infineon.com)）。

#### 警告事项

由于技术所需产品可能含有危险物质。如需了解该等物质的类型，请向离您最近的英飞凌科技办公室接洽。

除非由经英飞凌科技授权代表签署的书面文件中做出另行明确批准的情况外，英飞凌科技的产品不当被用于任何一项一旦产品失效或者产品使用的后果可被合理地预料到可能导致人身伤害的任何应用领域。

#### IMPORTANT NOTICE

The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics ("Beschaffheitsgarantie"). With respect to any examples, hints or any typical values stated herein and/or any information regarding the application of the product, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation warranties of non-infringement of intellectual property rights of any third party.

In addition, any information given in this document is subject to customer's compliance with its obligations stated in this document and any applicable legal requirements, norms and standards concerning customer's products and any use of the product of Infineon Technologies in customer's applications.

The data contained in this document is exclusively intended for technically trained staff. It is the responsibility of customer's technical departments to evaluate the suitability of the product for the intended application and the completeness of the product information given in this document with respect to such application.

For further information on the product, technology, delivery terms and conditions and prices please contact your nearest Infineon Technologies office ([www.infineon.com](http://www.infineon.com)).

#### WARNINGS

Due to technical requirements products may contain dangerous substances. For information on the types in question please contact your nearest Infineon Technologies office.

Except as otherwise explicitly approved by Infineon Technologies in a written document signed by authorized representatives of Infineon Technologies, Infineon Technologies' products may not be used in any applications where a failure of the product or any consequences of the use thereof can reasonably be expected to result in personal injury.